

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

James M. Derderian

**Serial No.:** 10/770,890

**Filed:** February 2, 2004

**For:** METHODS FOR FORMING  
ASSEMBLIES AND PACKAGES THAT  
INCLUDE STACKED SEMICONDUCTOR  
DEVICES SEPARATED A DISTANCE  
DEFINED BY ADHESIVE MATERIAL  
INTERPOSED THEREBETWEEN

**Confirmation No.:** 1094

**Examiner:** L. Thai

**Group Art Unit:** 2891

**Attorney Docket No.:** 2269-4817.3US  
(01-0103.03/US)

VIA ELECTRONIC FILING  
July 10, 2007

**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
PO Box 1450  
Alexandria, VA 22313-1450

Examiner:

This Amendment follows the Office Action of April 11, 2007, the shortened statutory period for response to which expires on July 11, 2007

A listing of claims, in which amendments to the claims are presented, begins on page 2 of this paper; and

Remarks start at page 8 of this paper.